

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of	:	Customer Number: 89518
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LIN, Mou-Shiung, et al.	:	Confirmation Number: 6103
	:	
Application No.: 10/055,560	:	Group Art Unit: 2813
	:	
Filed: January 22, 2002	:	Examiner: MITCHELL, James M.
	:	

For: INTEGRATED CHIP PACKAGE STRUCTURE USING METAL SUBSTRATE AND  
METHOD OF MANUFACTURING THE SAME

**AMENDMENT**

Mail Stop RCE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**CERTIFICATE OF ELECTRONIC TRANSMISSION**

I hereby certify that this correspondence is being electronically-transmitted to  
the United States Patent and Trademark Office on **January 21, 2011**,  
\_\_\_\_\_/Nicole San Nicolas/  
Nicole San Nicolas

Sir:

Entry of the following amendments and consideration of the following remarks are respectfully  
requested.

**Amendments** to the claims are reflected in the listing of claims which begins on page 2  
of this paper.

**Remarks** begin on page 9 of this paper.

An **Appendix** is attached after the last page, which shows the status of related cases.